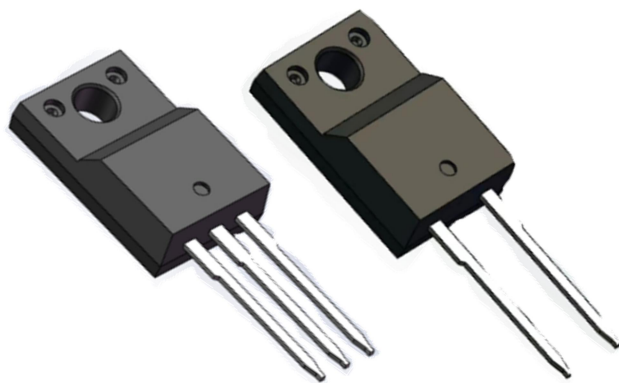


Isolation TO-220



ITO-220AB

ITO-220AC

1: Certification

- System:
 - IATF 16949
 - ISO9001
 - ISO14001
 - ISO45001
- ROHS/REACH/ELV:
 - Lead frame、Wire, Molding compound、Post plating.
- UL 94: V-0
- Whisker Test: JESD 201 class 1A
- AEC-Q101 (Rev E): Qualified Available
- Solder bath temperature : 275°C maximum, 10 s

2: Product advantage

2.1 Isolation Characteristics

The isolation voltage test value of the similar type of product is 2500V in the industry.

Package	Symbol	Parameter	Conditions	Max	Unit
ITO-220 (E-tech)	V isol	RMS isolation Voltage	50Hz≤f≤Hz; RH≤65% from pins to external heatsink sinusoidal waveform clean and dust free	3500	V
ITO-220 (others)				2500	

2.2 Thermal characteristics

Thermal resistance capacity is 2 times than similar product in the industry.

Data comparison between ITO-220 and ITO-220 in the industry (Die size: 150mil):

Package	Symbol	Parameter	Conditions	Max	Unit
ITO-220 (E-tech)	Rth (j-mb)	Thermal resistance from junction to mounting base	Full cycle	3	K/W
ITO-220 (others)				5.5	

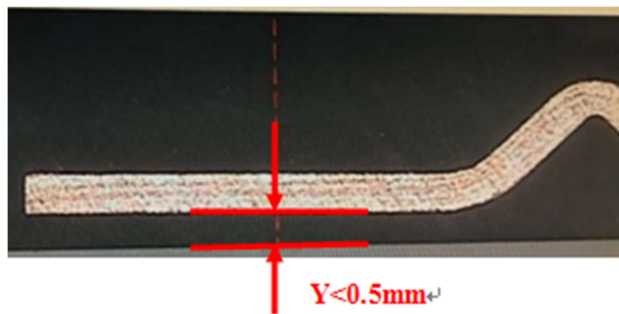
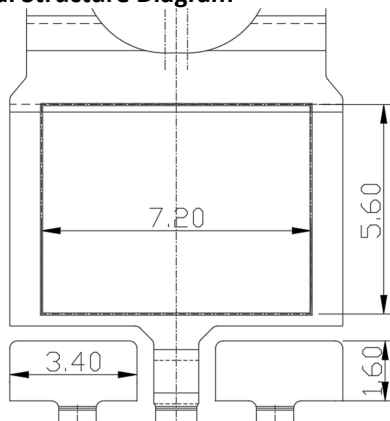
2.3 Mounting torque characteristics

Circular hole heat sink cause 10N torque of the screw hole, Only 5N torque on similar product in the industry.

Data comparison (Die size: 150mil):

Package	Symbol	Parameter	Conditions	Max	Unit
ITO-220 (E-Tech)	Mounting torque	Isolated heat sink mounted	1 mounting hole	10	N
ITO-220 (others)				5	

3: Internal Structure Diagram



Compound thickness from heat sink to backside: < 0.5mm.

Meet Die Size

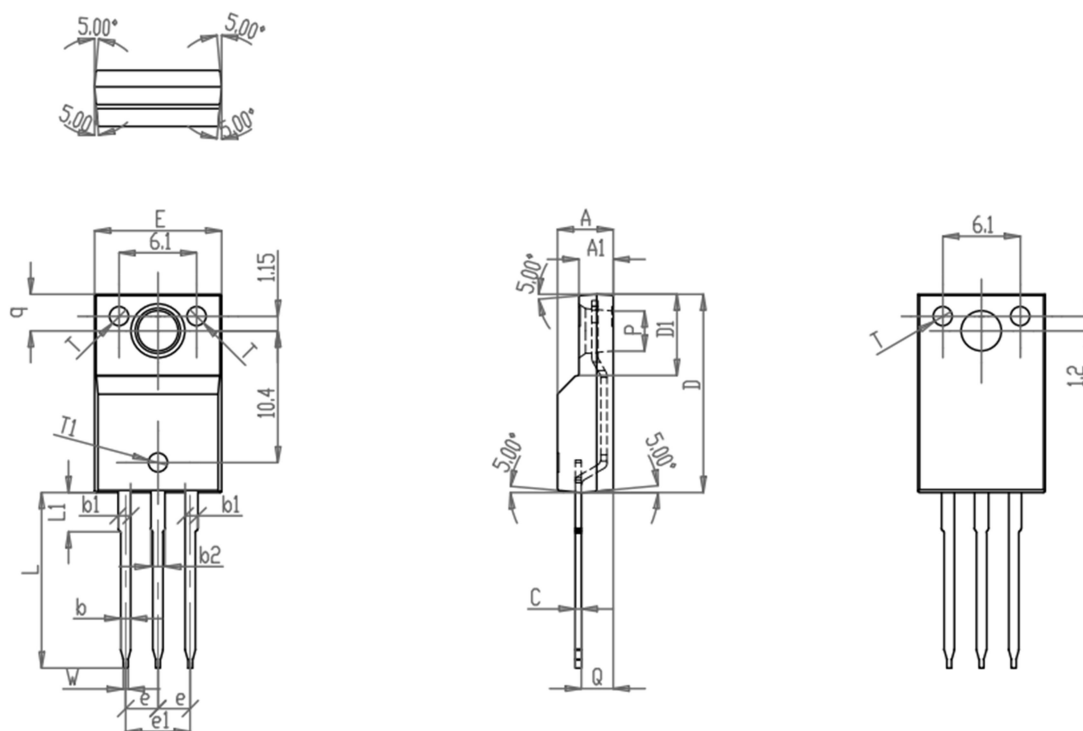
Die Pad(mm)	Die size(mm)	
X=7.20, Y=5.60	Double die (Max)	Single die(Max)
	X=2.85, Y=5.25	X=7.2, Y=5.25

4: Reliability Experiment

	Test	Test Condition
1	Temperature Cycle (TMCL)	500 cycles at -55°C to 150°C
2	Unbiased Highly Accelerated Stress Test (UHST)	96 hours at Ta = 130°C, RH = 85% ;P=2.27atm.
3	High Temperature, Humidity & Reverse Bias (THBS)	1000 hours at Tj = 85°C, RH = 85%, Reverse Bias = 80% rated voltage
4	Thermal Fatigue (TFAT)	10000 cycles, Tj = 25°C to 125°C, DTj ≥ 80°C, Id=depends on device & Ton = Toff ~2.5 to 3.5 mins.
5	Static High Temperature Life (SHTL)	1000 hours – Tj = max operating temp, Reverse Bias = 80% / 100% rated voltage.
6	High Temperature Storage (HTSL)	1000 hours at Ta = 150°C or Ta=175°C

5: Package Outline Dimensions in millimeters

5.1 POD



SYMBOL	MILLIMETERS			NOTES	SYMBOL	MILLIMETERS			NOTES
	Normal	MIN.	MAX.			Normal	MIN.	MAX.	
A	4.4	4.2	4.6		e1	5.08	5	5.12	
A1	2.7	2.5	2.9		L	13.90	13.5	14.4	
b	0.8	0.7	0.9		L1	3.12	2.8	3.3	
b1	1.07	0.9	1.3		P	3.14	3.00	3.20	
b2	1.17	1	1.4		Q	2.44	2.3	2.6	
C	0.5	0.4	0.6		q	2.87	2.6	3	
D	15.63	15.4	15.8		W	0.37	0.3	0.5	
D1	6.22	6	6.4		T	1.52	1.3	1.7	
E	10.06	9.7	10.3		T1	1.20	1.1	1.3	
e	2.54	2.5	2.58						